

Microsemi Corporation

January 30, 2014

Customer Notification No: CN1308

Subject: Systematic offset updated in external temperature monitor for Fusion® devices

Dear Customer,

Temperature offset for external temperature monitor is updated for Fusion devices in "Table 2-49: Analog Channel Specifications" in the previous Revision 4 of the datasheet.

The following parameters are updated –

- Calibrated systematic offset value for AFS090, AFS250, AFS600 and AFS1500 devices is updated to +/-5°C to reflect the limitation of the manufacturing test equipment. A system-level calibration with post processing is required to achieve a 0°C offset.
- Uncalibrated systematic offset value for AFS250,AFS600 and AFS1500 devices is updated to 5°C.

The updated calibrated and uncalibrated systematic offsets for external temperature monitor in Fusion devices are shown in the following table.

Table 2-49 • Analog Channel Specifications (continued)

Commercial Temperature Range Conditions, T_J = 85°C (unless noted otherwise),

Typical: VCC33A = 3.3 V, VCC = 1.5 V

Parameter	Description	Condition	Min.	Тур.	Max.	Units
Temperature Monitor Using Analog Pad AT						
External Temperature Monitor (external diode 2N3904, T _J = 25°C) ⁴	Resolution	8-bit ADC	4			°C
		10-bit ADC	1			°C
		12-bit ADC		°C		
	Systematic Offset ⁵	AFS090, AFS250, AFS600, AFS1500, uncalibrated ⁷	5			°C
		AFS090, AFS250, AFS600, AFS1500, calibrated ⁷	±5			°C
	Accuracy			±3	±5	°C
	External Sensor Source Current	High level, TMSTBx = 0		10		μA
		Low level, TMSTBx = 1		100		μA
	Max Capacitance on AT pad				1.3	nF

Contact Information: Microsemi SoC Products Group

For any clarifications or questions, please contact Microsemi SoC Tech Support



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Regards, Microsemi Corporation

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